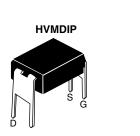


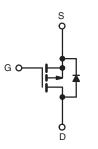
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Vishay Siliconix

COMPLIANT

# **Power MOSFET**





P-Channel MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	-10	-100			
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = -10 V	0.60			
Q <sub>g</sub> max. (nC)	18	18			
Q <sub>gs</sub> (nC)	3.0	3.0			
Q <sub>gd</sub> (nC)	9.0	9.0			
Configuration	Sing	Single			

#### **FEATURES**

- · Dynamic dv/dt rating
- Repetitive avalanche rated
- For automatic Insertion
- End stackable
- P-channel
- 175 °C operating temperature
- Fast switching
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **DESCRIPTION**

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serves as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION				
Package	HVMDIP			
Lead (Pb)-free	IRFD9120PbF			
Leau (FD)-IIee	SiHFD9120-E3			

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	-100	V	
Gate-source voltage			$V_{GS}$	± 20	V	
Continuous dusin surrent	$V_{GS}$ at -10 V $T_A = 25  ^{\circ}$ C $T_A = 100  ^{\circ}$ C	T <sub>A</sub> = 25 °C	- I <sub>D</sub>	-1.0	А	
Continuous drain current		T <sub>A</sub> = 100 °C		-0.70		
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	-8.0	1	
Linear derating factor				0.0083	W/°C	
Single pulse avalanche energy b			E <sub>AS</sub>	140	mJ	
Repetitive avalanche current a			I <sub>AR</sub>	-1.0	Α	
Repetitive avalanche energy <sup>a</sup>			E <sub>AR</sub>	0.13	mJ	
Maximum power dissipation	on T <sub>A</sub> = 25 °C		P <sub>D</sub>	1.3	W	
Peak diode recovery dv/dt <sup>c</sup>			dv/dt	-5.5	V/ns	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	- °C	
Soldering rRecommendations (peak temperature) <sup>d</sup>	for 10 s		-	300		

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b.  $V_{DD} = -25 \text{ V}$ , starting  $T_J = 25 \,^{\circ}\text{C}$ , L = 52 mH,  $R_g = 25 \,\Omega$ ,  $I_{AS} = -2.0 \,\text{A}$  (see fig. 12)
- c.  $I_{SD} \le -6.8$  A, di/dt  $\le 110$  A/ $\mu$ s,  $V_{DD} \le V_{DS}$ ,  $T_J \le 175$  °C
- d. 1.6 mm from case



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THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	-	120	°C/W		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static					L	L	
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$		-100	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I <sub>D</sub> = -1 mA	-	-0.10	-	V/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	V <sub>GS</sub> , I <sub>D</sub> = -250 μA	-2.0	-	-4.0	V
Gate-source leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
	I <sub>DSS</sub>	$V_{DS} = -100 \text{ V}, V_{GS} = 0 \text{ V}$		-	-	-100	
Zero gate voltage drain current		V <sub>DS</sub> = -80 V	', V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C	-	-	-500	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = -10 V	I <sub>D</sub> = -0.6 A <sup>b</sup>	-	-	0.60	Ω
Forward transconductance	9 <sub>fs</sub>	$V_{DS} = -$	-50 V, I <sub>D</sub> = -0.60 A <sup>b</sup>	0.71	-	-	S
Dynamic							
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V		-	390	-	pF
Output capacitance	C <sub>oss</sub>		V <sub>DS</sub> = -25 V f = 1.0 MHz, see fig. 5		170	-	
Reverse transfer capacitance	C <sub>rss</sub>	f = 1			45	-	
Total gate charge	Q <sub>g</sub>			-	-	18	nC
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = -10 V	V <sub>GS</sub> = -10 V		-	3.0	
Turn-on delay time	Q <sub>gd</sub>	1	see lig. 6 and 15	-	-	9.0	1
Rise time	t <sub>d(on)</sub>			-	9.6	-	
Turn-off delay time	t <sub>r</sub>	$V_{DD}$ = -50 V, $I_D$ = -6.8 A $R_g$ = 18 $\Omega$ , $R_D$ = 7.1 $\Omega$ , see fig. 10 b		-	29	-	ns
Fall time	t <sub>d(off)</sub>			-	21	-	
Turn-on delay time	t <sub>f</sub>			-	25	-	
Internal drain inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.0	-	nH
Internal source inductance	L <sub>S</sub>			-	6.0	-	] IIII
<b>Drain-Source Body Diode Characteristic</b>	cs						
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p -n junction diode		ı	-	-1.0	A
Pulsed diode forward current <sup>a</sup>	I <sub>SM</sub>			-	-	-8.0	
Body diode voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = -1.0 A, V <sub>GS</sub> = 0 V <sup>b</sup>		-	-	-6.3	V
Body diode reverse recovery time	t <sub>rr</sub>	T 05.00 !	0.0 A 35/31 400 A/ b	-	98	200	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	$T_J = 25  ^{\circ}\text{C}, I_F = -6.8  \text{A},  \text{di/dt} = 100  \text{A/} \mu \text{s}^{ \text{b}}$		-	0.33	0.66	μC
Forward turn-on time	t <sub>on</sub>	Intrinsic tu	ırn-on time is negligible (turn	on is dor	ninated b	v I s and	[ D)

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

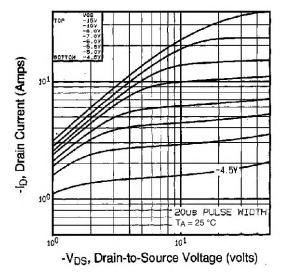


Fig. 1 - Typical Output Characteristics,  $T_A = 25$  °C

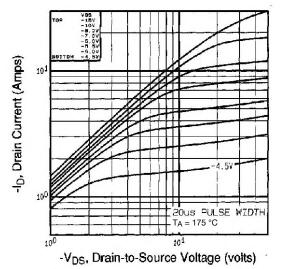


Fig. 2 - Typical Output Characteristics,  $T_A$  = 175 °C

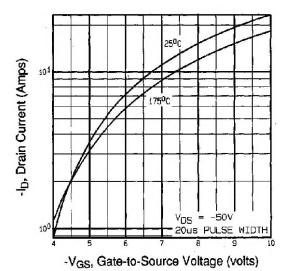


Fig. 3 - Typical Transfer Characteristics

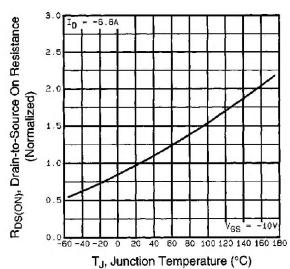


Fig. 4 - Normalized On-Resistance vs. Temperature



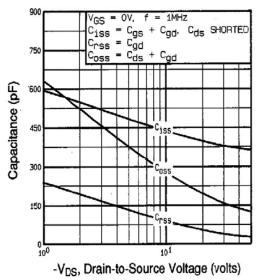


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

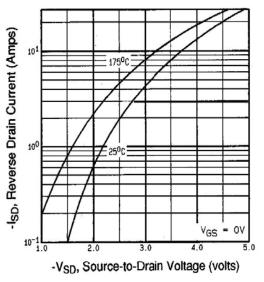


Fig. 7 - Typical Source-Drain Diode Forward Voltage

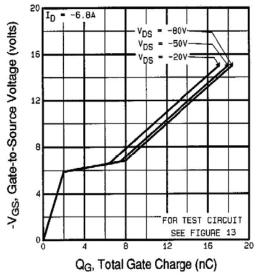


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

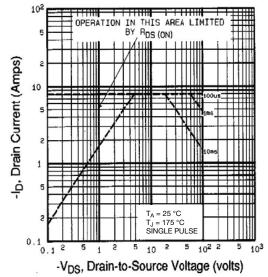


Fig. 8 - Maximum Safe Operating Area



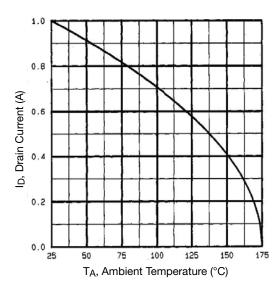


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

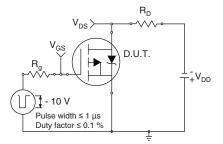


Fig. 10a - Switching Time Test Circuit

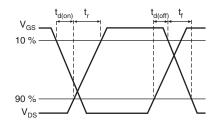


Fig. 10b - Switching Time Waveforms

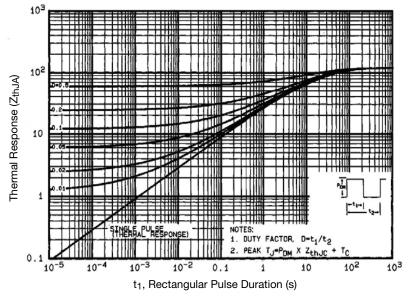


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



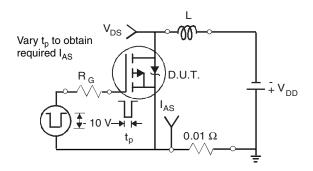


Fig. 12a - Unclamped Inductive Test Circuit

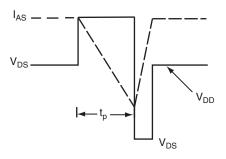


Fig. 12b - Unclamped Inductive Waveforms

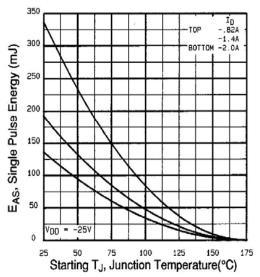


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

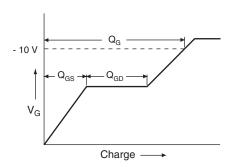


Fig. 13a - Basic Gate Charge Waveform

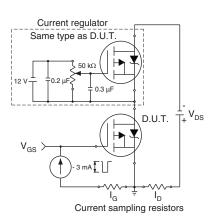
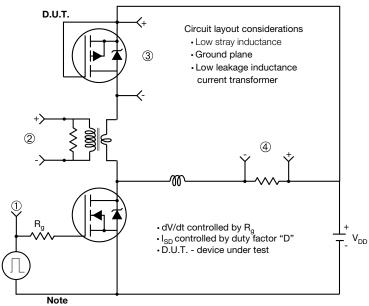


Fig. 13b - Gate Charge Test Circuit



## Peak Diode Recovery dV/dt Test Circuit



• Compliment N-Channel of D.U.T. for driver

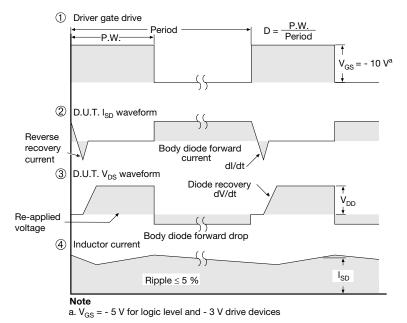
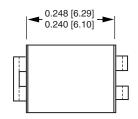


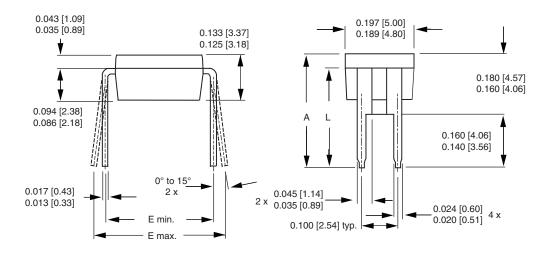
Fig. 14 - For P-Channel

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## **HVM DIP** (High voltage)





	INCHES		MILLIMETERS		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	0.310	0.330	7.87	8.38	
E	0.300	0.425	7.62	10.79	
L	0.270	0.290	6.86	7.36	

ECN: X10-0386-Rev. B, 06-Sep-10

DWG: 5974

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.

Document Number: 91361 Revision: 06-Sep-10



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